

Industriel Mini-ITX bundkort til Intel® 6./7. generations processor

FEATURES

Intel® 7. / 6. Skylake Gen-S / S-Kaby Lake Series med Q170 / H110

2 X DDR4 2400 MHz SODIMM-slots op til 32 GB

Tredobbelt uafhængige skærme: 2 X DVI-D, DP

(HDMI option), LVDS til 4 X GbE LAN med RJ-45

1x PCIe x16 (Gen3), 1x Mini-PCIe (fuld størrelse, med SIM-holder) slots

1 X Pattern 2 M Key, 2 x SATA 3.0 til opbevaring

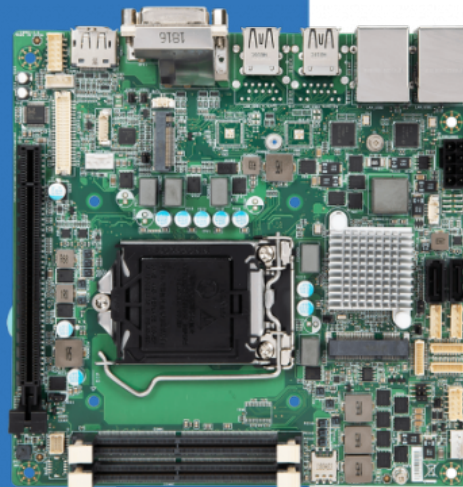
SATA RAID 0/1/5 (RAID 5 konfigureret med Pattern

2 M Key) til 8 X USB 3.2 Gen 1, 3 X USB 2.0, 4 X

COM (4 RS-485), GPIO, Audio, System FAN

SMBus, Chassis Intrusion

Forsyningsspænding: 12 ~ 24V DC



SPECIFICATIONS

CPU	:	Socket (LGA 1151)
Chipset	:	Intel® Q170 Express
USB	:	3 x USB 2.0 (internal), 8 x USB 3.2 Gen 1 (rear)
Driftstemperatur	:	-10 ~ 60°C
Forsyning	:	DC-in 12 ~24V
GPIO	:	16-bits (8 x GPI; 8 x GPO), 5V
Grafik	:	2 X (DVI-D), 1 X (DP), 1 X LVDS
Hukommelse	:	2 X DDR4 2400 MHz SODIMM slots up to 32GB
Lyd	:	Realtek® ALC887 HD Audio Codec
OS SUPPORT	:	Windows 10 (64-bit), Windows 7 (32/64-bit) (Skylake-S Series only), Windows 8.1 (64-bit) (Skylake-S Series only), Linux Fedora 23 (by request), Linux Ubuntu 16.04 (by request)
PCI	:	1 X PCIe x 16 (Max 75W), 1 X Full-size Mini-PCIe
Porte	:	4 x COM ports (Internal), COM1: RS- 232/422/485,RI/5V/12V COM2~4: RS- 232/422/485,0V/5V/12V



**DANBIT**

BK1151-MITX-Q170

SPECIFICATIONS

Dimensioner	:	170 x 170mm (Mini-ITX)
Certifications	:	FCC, CE , RCM, VCCI, BSMI (Class A)



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